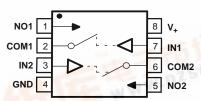


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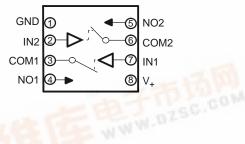
#### **FEATURES**

- Low ON-State Resistance (10 Ω)
- Control Inputs Are 5-V Tolerant
- Low Charge Injection
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)

SSOP OR VSSOP PACKAGE (TOP VIEW)



YEP OR YZP PACKAGE (BOTTOM VIEW)



#### **APPLICATIONS**

- Sample-and-Hold Circuits
- Battery-Powered Equipment
- Audio and Video Signal Routing
- Communication Circuits
- Cell Phones
- Low-Voltage Data-Acquisition Systems
- PDAs

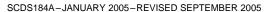
#### **DESCRIPTION/ORDERING INFORMATION**

The TS5A2066 is a dual single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. This device can handle both digital and analog signals, and signals up to  $V_{+}$  can be transmitted in either direction.

## Summary of Characteristics $V_+ = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$

Configuration	Dual Single Pole Single Throw (2 × SPST)
Number of channels	2
ON-state resistance (r <sub>on</sub> )	7.5 Ω
ON-state resistance match ( $\Delta r_{on}$ )	0.4 Ω
ON-state resistance flatness (r <sub>on(flat)</sub> )	3.5 Ω
Turn-on/turn-off time (t <sub>ON</sub> /t <sub>OFF</sub> )	5.8 ns/3.6 ns
Charge injection (Q <sub>C</sub> )	1 pC
Bandwidth (BW)	400 MHz
OFF isolation (O <sub>ISO</sub> )	-68 dB
Crosstalk (X <sub>TALK</sub> )	-66 dB
Total harmonic distortion (THD)	0.01%
Leakage current (I <sub>COM(OFF)</sub> /(I <sub>NC(OFF)</sub>	±50 nA
Power-supply current (I <sub>+</sub> )	0.1 μΑ
Package options	8-pin DSBGA, SSOP, or VSSOP

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





#### ORDERING INFORMATION

T <sub>A</sub>	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING (2)
	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	\ / /		
-40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Tape and reel	TS5A2066YZPR	PREVIEW
	SSOP - DCT	Tape and reel	TS5A2066DCTR	PREVIEW
	VSSOP - DCU	Tape and reel	TS5A2066DCUR	JAG_

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site. DCU: The actual top-side marking has one additional character that designates the assembly/test site YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, = Pb-free).

#### **FUNCTION TABLE**

IN	NO TO COM, COM TO NO
L	OFF
Н	ON

### Absolute Minimum and Maximum Ratings (1)(2)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>+</sub>	Supply voltage range <sup>(3)</sup>		-0.5	6.5	V
$V_{NO} \ V_{COM}$	Analog voltage range (3) (4) (5)		-0.5	V <sub>+</sub> + 0.5	V
$I_{K}$	Analog port diode current	$V_{NO}$ , $V_{COM} < 0$ or $V_{NO}$ , $V_{COM} > V_{+}$	-50	50	mA
$I_{NO}$ $I_{COM}$	On-state switch current	$V_{NO}$ , $V_{COM} = 0$ to $V_{+}$	-50	50	mA
$V_{I}$	Digital input voltage range (3) (4)		-0.5	6.5	V
$I_{IK}$	Digital input clamp current	V <sub>1</sub> < 0	-50		mA
I <sub>+</sub>	Continuous current through V <sub>+</sub>			100	mA
$I_{GND}$	Continuous current through GND		-100	100	mA
		DCT package		220	
$\theta_{JA}$	Package thermal impedance (6)	DCU package		227	°C/W
		YEP/YZP package		102	
T <sub>stg</sub>	Storage temperature range		-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
- (3) All voltages are with respect to ground, unless otherwise specified.
- 4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed
- (5) This value is limited to 5.5 V maximum.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.



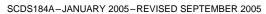
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### Electrical Characteristics for 5-V Supply<sup>(1)</sup>

 $\rm V_{\scriptscriptstyle +} = 4.5~V$  to 5.5 V,  $\rm T_{\rm A} = -40^{\circ}C$  to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST	CONDITIONS	T <sub>A</sub>	V <sub>+</sub>	MIN	TYP	MAX	UNIT
Analog Switch						•		<u> </u>	
Analog signal range	V <sub>COM</sub> , V <sub>NO</sub>					0		V <sub>+</sub>	V
ON-state resistance	r <sub>on</sub>	$0 \le V_{NO} \le V_{+},$ $I_{COM} = -32 \text{ mA},$	Switch ON, See Figure 13	25°C Full	4.5 V		7.5	10 15	Ω
ON-state				25°C			0.4	1	
resistance match between channels	$\Delta r_{\sf on}$	$V_{NO} = 3.15 \text{ V},$ $I_{COM} = -32 \text{ mA},$	Switch ON, See Figure 13	Full	4.5 V			3	Ω
ON-state		$0 \le V_{NO} \le V_+$	Switch ON,	25°C		2	3.5	5	
resistance flatness	r <sub>on(flat)</sub>	$I_{COM} = -32 \text{ mA},$	See Figure 13	Full	4.5 V	4		8	Ω
		V <sub>NO</sub> = 1 V,		25°C		-30	-10	30	
NO OFF leakage current	I <sub>NO(OFF)</sub>	$V_{COM} = 4.5 \text{ V},$ or $V_{NO} = 4.5 \text{ V},$ $V_{COM} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	5.5 V	-40		40	nA
		$V_{COM} = 1 V$ ,		25°C		-50	-8	50	
COM OFF leakage current	I <sub>COM(OFF)</sub>	$V_{NO} = 4.5 \text{ V},$ or $V_{COM} = 4.5 \text{ V},$ $V_{NO} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	5.5 V	-50		50	nA
		V <sub>NO</sub> = 1 V,		25°C		-40	-12	40	
NO ON leakage current	I <sub>NO(ON)</sub>	$V_{COM} = Open,$ or $V_{NO} = 4.5 V,$ $V_{COM} = Open$	Switch ON, See Figure 15	Full	5.5 V	-4		40	nA
		$V_{COM} = 1 V$ ,		25°C		-70	-30	70	
COM ON leakage current	I <sub>COM(ON)</sub>	$V_{NO}$ = Open, or $V_{COM}$ = 4.5 V, $V_{NO}$ = Open,	Switch ON, See Figure 15	Full	5.5 V	-7-		70	nA
Digital Control In	put (IN)			•	•	•			
Input logic high	$V_{IH}$			Full		$V_+ \times 0.7$		5.5	V
Input logic low	$V_{IL}$			Full		0		$V_{+} \times 0.3$	V
Input leakage	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>I</sub> = 5.5 V or 0		25°C	5.5 V	-0.1	0.05	0.1	μА
current		•		Full		-1		1	•

<sup>(1)</sup> The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum





#### **Electrical Characteristics for 5-V Supply (continued)**

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$ 

PARAMETER	SYMBOL	TEST C	ONDITIONS	T <sub>A</sub>	V <sub>+</sub>	MIN	TYP	MAX	UNIT
Dynamic									
		V 2.V	C 25 pF	25°C	5 V	4.4	5.2	5.8	
Turn-on time	t <sub>ON</sub>	$V_{COM} = 3 V,$ $R_L = 300 \Omega,$	C <sub>L</sub> = 35 pF, See Figure 17	Full	4.5 V to 5.5 V	3.4		6.1	ns
		V 2.V	0 25 -5	25°C	5 V	1.7	2.6	3.6	
Turn-off time	t <sub>OFF</sub>	$V_{COM} = 3 \text{ V},$ $R_L = 300 \Omega,$	C <sub>L</sub> = 35 pF, See Figure 17	Full	4.5 V to 5.5 V	1.3		4.2	ns
Charge injection	Q <sub>C</sub>	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C <sub>L</sub> = 0.1 nF, See Figure 21	25°C	5 V		1		рС
NO OFF capacitance	C <sub>NO(OFF)</sub>	$V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	5 V		5.5		pF
COM OFF capacitance	C <sub>COM(OFF)</sub>	V <sub>COM</sub> = V <sub>+</sub> or GND, Switch OFF,	See Figure 16	25°C	5 V		5.5		pF
NO ON capacitance	C <sub>NO(ON)</sub>	$V_{NO} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	5 V		13.5		pF
COM ON capacitance	C <sub>COM(ON)</sub>	V <sub>COM</sub> = V <sub>+</sub> or GND, Switch ON,	See Figure 16	25°C	5 V		13.5		pF
Digital input capacitance	Cı	$V_I = V_+ \text{ or GND},$	See Figure 16	25°C	5 V		2.5		pF
Bandwidth	BW	$R_L = 50 \Omega$ , Switch ON,	See Figure 18	25°C	5 V		300		MHz
OFF isolation	O <sub>ISO</sub>	$R_L = 50 \Omega$ , f = 10 MHz,	Switch OFF, See Figure 19	25°C	5 V		-68		dB
Crosstalk	X <sub>TALK</sub>	$R_L = 50 \Omega$ , f = 10 MHz,	Switch ON, See Figure 20	25°C	5 V		-66		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 22	25°C	5 V		0.01		%
Supply				•					
Positive supply		V V or CND	Switch ON or OFF	25°C	E E V		0.1	1	^
current	I <sub>+</sub>	$V_I = V_+ \text{ or GND},$	Switch ON or OFF	Full	5.5 V			5	μΑ



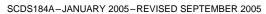
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### Electrical Characteristics for 3.3-V Supply<sup>(1)</sup>

 $\rm V_{\scriptscriptstyle +} = 3~V$  to 3.6 V,  $\rm T_{\rm A} = -40^{\circ}C$  to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST (	CONDITIONS	T <sub>A</sub>	V <sub>+</sub>	MIN	TYP	MAX	UNIT
Analog Switch					•	•			
Analog signal range	V <sub>COM</sub> , V <sub>NO</sub>					0		V <sub>+</sub>	V
ON-state resistance	r <sub>on</sub>	$0 \le V_{NO} \le V_{+},$ $I_{COM} = -24 \text{ mA},$	Switch ON, See Figure 13	25°C Full	3 V	10 12	12	15 20	Ω
ON-state				25°C		0.04	0.5	1.5	
resistance match between channels	$\Delta r_{\sf on}$	$V_{NO} = 2.1 \text{ V},$ $I_{COM} = -24 \text{ mA},$	Switch ON, See Figure 13	Full	3 V	0.01		3.5	Ω
ON-state		$0 \le V_{NO} \le V_+$	Switch ON,	25°C		6	7	8	
resistance flatness	r <sub>on(flat)</sub>	$I_{COM} = -24 \text{ mA},$	See Figure 13	Full	3 V	9		12	Ω
		V <sub>NO</sub> = 1 V,		25°C		-30	-6	30	
NO OFF leakage current	I <sub>NO(OFF)</sub>	$V_{COM} = 3 \text{ V},$ or $V_{NO} = 3 \text{ V},$ $V_{COM} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	3.6 V	-40		40	nA
		$V_{COM} = 1 V$ ,		25°C		-50	-7	50	
COM OFF leakage current	I <sub>COM(OFF)</sub>	$V_{NO} = 3 V$ , or $V_{COM} = 3 V$ , $V_{NO} = 1 V$ ,	Switch OFF, See Figure 14	Full	3.6 V	-50		50	nA
		$V_{NO} = 1 V$ ,		25°C		-40	-7	40	
NO ON leakage current	I <sub>NO(ON)</sub>	$V_{COM} = Open,$ or $V_{NO} = 3 V,$ $V_{COM} = Open$	Switch ON, See Figure 15	Full	3.6 V	-40		40	nA
		V <sub>COM</sub> = 1 V,		25°C		-70	-20	70	
COM ON leakage current	I <sub>COM(ON)</sub>	$V_{NO}$ = Open, or $V_{COM}$ = 3 V, $V_{NO}$ = Open,	Switch ON, See Figure 15	Full	3.6 V	-70		70	nA
Digital Control Inp	out (IN)							1	
Input logic high	$V_{IH}$			Full		$V_+ \times 0.7$		5.5	V
Input logic low	$V_{IL}$			Full		0		V <sub>+</sub> × 0.3	V
Input leakage	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>I</sub> = 5.5 V or 0		25°C	3.6 V	-0.1	0.05	0.1	μА
current	יווי יונ	1, 0.0 . 0. 0		Full	0.0 .	-1		1	

<sup>(1)</sup> The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum





#### **Electrical Characteristics for 3.3-V Supply (continued)**

 $V_{+} = 3 \text{ V}$  to 3.6 V,  $T_{A} = -40^{\circ}\text{C}$  to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CO	NDITIONS	$T_A$	V <sub>+</sub>	MIN	TYP	MAX	UNIT
Dynamic								<u>.</u>	
		.,	0 05 - 5	25°C	3.3 V	4.9	5.6	6.4	
Turn-on time	t <sub>ON</sub>	$V_{COM} = 2 \text{ V},$ $R_L = 300 \Omega,$	C <sub>L</sub> = 35 pF, See Figure 17	Full	3 V to 3.6 V	4.3		7.1	ns
		.,	0 25 - 5	25°C	3.3 V	2	2.7	3.7	
Turn-off time	t <sub>OFF</sub>	$V_{COM} = 2 \text{ V},$ $R_L = 300 \Omega,$	C <sub>L</sub> = 35 pF, See Figure 17	Full	3 V to 3.6 V	1.3		4.7	ns
Charge injection	Q <sub>C</sub>	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C <sub>L</sub> = 0.1 nF, See Figure 21	25°C	3.3 V		0.5		рС
NO OFF capacitance	C <sub>NO(OFF)</sub>	V <sub>NO</sub> = V <sub>+</sub> or GND, Switch OFF,	See Figure 16	25°C	3.3 V		5.5		pF
COM OFF capacitance	C <sub>COM(OFF)</sub>	V <sub>COM</sub> = V <sub>+</sub> or GND, Switch OFF,	See Figure 16	25°C	3.3 V		6		pF
NO ON capacitance	C <sub>NO(ON)</sub>	V <sub>NO</sub> = V <sub>+</sub> or GND, Switch ON,	See Figure 16	25°C	3.3 V		14		pF
COM ON capacitance	C <sub>COM(ON)</sub>	V <sub>COM</sub> = V <sub>+</sub> or GND, Switch ON,	See Figure 16	25°C	3.3 V		14		pF
Digital input capacitance	C <sub>I</sub>	$V_I = V_+$ or GND,	See Figure 16	25°C	3.3 V		3		pF
Bandwidth	BW	$R_L = 50 \Omega$ , Switch ON,	See Figure 18	25°C	3.3 V		300		MHz
OFF isolation	O <sub>ISO</sub>	$R_L = 50 \Omega$ , $f = 10 MHz$ ,	Switch OFF, See Figure 19	25°C	3.3 V		-68		dB
Crosstalk	X <sub>TALK</sub>	$R_L = 50 \Omega$ , $f = 10 MHz$ ,	Switch ON, See Figure 20	25°C	3.3 V		-66		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 22	25°C	3.3 V		0.065		%
Supply				•				'	
Positive supply	1	V V or CND	Switch ON or OFF	25°C	3.6 V		0.1	1	^
current	I <sub>+</sub>	$V_I = V_+ \text{ or GND},$	SWILCH ON OF OFF	Full	3.6 V			5	μΑ



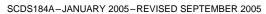
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### Electrical Characteristics for 2.5-V Supply<sup>(1)</sup>

 $\rm V_{+} = 2.3~V$  to 2.7 V,  $\rm T_{A} = -40^{\circ}C$  to  $85^{\circ}C$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST	CONDITIONS	T <sub>A</sub>	V <sub>+</sub>	MIN	TYP	MAX	UNIT
Analog Switch	•								
Analog signal range	V <sub>COM</sub> , V <sub>NO</sub>					0		V <sub>+</sub>	V
ON-state resistance	r <sub>on</sub>	$0 \le V_{NO} \le V_{+},$ $I_{COM} = -8 \text{ mA},$	Switch ON, See Figure 13	25°C Full	2.3 V	20	22	25 30	Ω
ON-state				25°C		0.04	0.5	1.5	
resistance match between channels	$\Delta r_{\sf on}$	$V_{NO} = 1.6 \text{ V},$ $I_{COM} = -8 \text{ mA},$	Switch ON, See Figure 13	Full	2.3 V	0.02		5	Ω
ON-state		$0 \le V_{NO} \le V_+$	Switch ON,	25°C	0.01/	12	16	18	
resistance flatness	ron (flat)	$I_{COM} = -8 \text{ mA},$	See Figure 13	Full	2.3 V	15		25	Ω
		V <sub>NO</sub> = 0.5 V,		25°C		-30	-5.5	30	
NO OFF leakage current	I <sub>NO(OFF)</sub>	$V_{COM} = 2.2 \text{ V},$ or $V_{NO} = 2.2 \text{ V},$ $V_{COM} = 0.5 \text{ V},$	Switch OFF, See Figure 14	Full	2.7 V	-40		40	nA
2014		$V_{COM} = 0.5 \text{ V},$		25°C		-50	-7.5	50	
COM OFF leakage current	I <sub>COM(OFF)</sub>	$V_{NO} = 2.2 \text{ V},$ or $V_{COM} = 2.2 \text{ V},$ $V_{NO} = 0.5 \text{ V},$	Switch OFF, See Figure 14	Full	2.7 V	-50		50	nA
		$V_{NO} = 0.5 V,$		25°C		-40	-5	40	
NO ON leakage current	I <sub>NO(ON)</sub>	$V_{COM} = Open,$ or $V_{NO} = 2.2 V,$ $V_{COM} = Open$	Switch ON, See Figure 15	Full	2.7 V	-40		40	nA
2011		$V_{COM} = 0.5 \text{ V},$		25°C		-70	-12	70	
COM ON leakage current	I <sub>COM(ON)</sub>	$V_{NO}$ = Open, or $V_{COM}$ = 2.2 V, $V_{NO}$ = Open,	Switch ON, See Figure 15	Full	2.7 V	-70		70	nA
Digital Control In	put (IN)								
Input logic high	V <sub>IH</sub>			Full		$V_+ \times 0.7$		5.5	V
Input logic low	V <sub>IL</sub>			Full		0		$V_{+} \times 0.3$	V
Input leakage current	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>I</sub> = 5.5 V or 0		25°C Full	2.7 V	-0.1 -1	0.05	0.1	μΑ

<sup>(1)</sup> The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum





#### **Electrical Characteristics for 2.5-V Supply (continued)**

 $V_{+}$  = 2.3 V to 2.7 V,  $T_{A}$  = -40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST C	ONDITIONS	TA	V <sub>+</sub>	MIN	TYP	MAX	UNIT
Dynamic									
		V 4.5.V	0 25 -5	25°C	2.5 V	5.7	6.4	8.1	
Turn-on time	t <sub>ON</sub>	$V_{COM} = 1.5 \text{ V},$ $R_L = 300 \Omega,$	C <sub>L</sub> = 35 pF, See Figure 17	Full	2.3 V to 2.7 V	4.4		8.5	ns
		V 45V	0 05 - 5	25°C	2.5 V	2.1	3.1	4.3	
Turn-off time	t <sub>OFF</sub>	$V_{COM} = 1.5 \text{ V},$ $R_L = 300 \Omega,$	C <sub>L</sub> = 35 pF, See Figure 17	Full	2.3 V to 2.7 V	1.8		4.8	ns
Charge injection	Q <sub>C</sub>	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C <sub>L</sub> = 0.1 nF, See Figure 20	25°C	2.5 V		0.5		рС
NO OFF capacitance	C <sub>NO(OFF)</sub>	$V_{NO} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	2.5 V		6		pF
COM OFF capacitance	C <sub>COM(OFF)</sub>	V <sub>COM</sub> = V <sub>+</sub> or GND, Switch OFF,	See Figure 16	25°C	2.5 V		6		pF
NO ON capacitance	C <sub>NO(ON)</sub>	$V_{NO} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	2.5 V		14		pF
COM ON capacitance	C <sub>COM(ON)</sub>	V <sub>COM</sub> = V <sub>+</sub> or GND, Switch ON,	See Figure 16	25°C	2.5 V		14		pF
Digital input capacitance	Cı	$V_I = V_+$ or GND,	See Figure 16	25°C	2.5 V		3		pF
Bandwidth	BW	$R_L = 50 \Omega$ , Switch ON,	See Figure 18	25°C	2.5 V		300		MHz
OFF isolation	O <sub>ISO</sub>	$R_L = 50 \Omega$ , f = 10 MHz,	Switch OFF, See Figure 19	25°C	2.5 V		-68		dB
Crosstalk	X <sub>TALK</sub>	$R_L = 50 \Omega$ , f = 10 MHz,	Switch ON, See Figure 20	25°C	2.5 V		-66		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 22	25°C	2.5 V		0.35		%
Supply		•							
Positive supply	I <sub>+</sub>	$V_1 = V_+ \text{ or GND},$	Switch ON or OFF	25°C	2.7 V		0.1	1	μА
current	'+	V <sub>1</sub> = V <sub>+</sub> OI OIVD,	Switch Old Old	Full	Z.1 V			5	μΑ



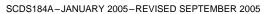
SCDS184A-JANUARY 2005-REVISED SEPTEMBER 2005

### Electrical Characteristics for 1.8-V Supply<sup>(1)</sup>

 $\rm V_{+} = 1.65~V$  to 1.95 V,  $\rm T_{A} = -40^{\circ}C$  to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST	CONDITIONS	TA	V.	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V <sub>COM</sub> , V <sub>NO</sub>					0		V <sub>+</sub>	V
ON-state resistance	r <sub>on</sub>	$0 \le V_{NO} \le V_{+},$ $I_{COM} = -4 \text{ mA},$	Switch ON, See Figure 13	25°C Full	1.65 V	80 90	85	95 120	Ω
ON-state				25°C		0	0.9	2	
resistance match between channels	$\Delta r_{\sf on}$	$V_{NO} = 1.15 \text{ V},$ $I_{COM} = -4 \text{ mA},$	Switch ON, See Figure 13	Full	1.65 V	0	0.0	6	Ω
ON-state		$0 \le V_{NO} \le V_+$	Switch ON,	25°C		70	75	85	-
resistance flatness	r <sub>on (flat)</sub>	$I_{COM} = -4 \text{ mA},$	See Figure 13	Full	1.65 V	85		100	Ω
		$V_{NO} = 0.3 V$ ,		25°C		-30	-6	30	
NO OFF leakage current	I <sub>NO(OFF)</sub>	$V_{COM} = 1.65 \text{ V},$ or $V_{NO} = 1.65 \text{ V},$ $V_{COM} = 0.3 \text{ V},$	Switch OFF, See Figure 14	Full	1.95 V	-40		40	nA
		$V_{COM} = 0.3 \text{ V},$		25°C		-50	-7	50	
COM OFF leakage current	I <sub>COM(OFF)</sub>	$V_{NO} = 1.65 \text{ V},$ or $V_{COM} = 1.65 \text{ V},$ $V_{NO} = 0.3 \text{ V},$	Switch OFF, See Figure 14	Full	1.95 V	-50		50	nA
		$V_{NO} = 0.3 V$ ,		25°C		-40	7	40	
NO ON leakage current	I <sub>NO(ON)</sub>	$V_{COM} = Open,$ or $V_{NO} = 1.65 V,$ $V_{COM} = Open$	Switch ON, See Figure 15	Full	1.95 V	-40		40	nA
		$V_{COM} = 0.3 V,$		25°C		-70	-8.5	70	
COM ON leakage current	I <sub>COM(ON)</sub>	$V_{NO}$ = Open, or $V_{COM}$ = 1.65 V, $V_{NO}$ = Open,	Switch ON, See Figure 15	Full	1.95 V	-70		70	nA
Digital Control In	put (IN)								
Input logic high	$V_{IH}$			Full		$V_+ \times 0.65$		5.5	V
Input logic low	$V_{IL}$			Full		0		$V_+ \times 0.35$	V
Input leakage current	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>I</sub> = 5.5 V or 0		25°C	1.95 V	-0.1	0.05	0.1	μΑ
Currerit				Full		-1		1	

<sup>(1)</sup> The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum





#### **Electrical Characteristics for 1.8-V Supply (continued)**

 $V_{+} = 1.65 \text{ V}$  to 1.95 V,  $T_{A} = -40^{\circ}\text{C}$  to 85°C (unless otherwise noted)

11.5 12.9 5.2 6.5	ns
12.9	
5.2	
	ns
6.5	ns
	pC
	pF
	MHz
	dB
	dB
	%
1	μΑ
	1 5



#### **TYPICAL PERFORMANCE**

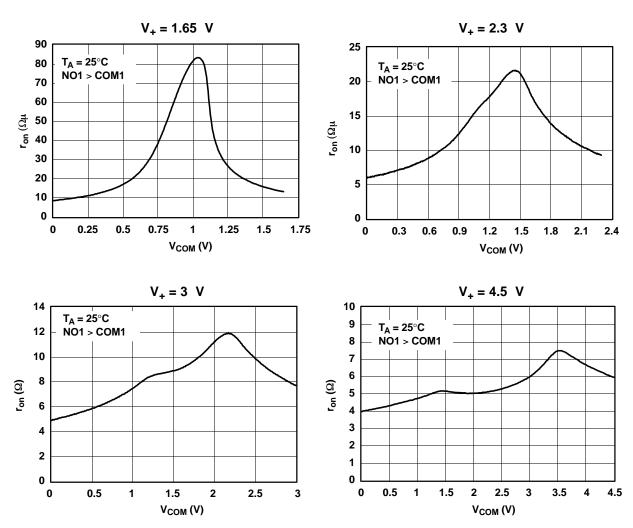


Figure 1. ron vs V<sub>COM</sub>

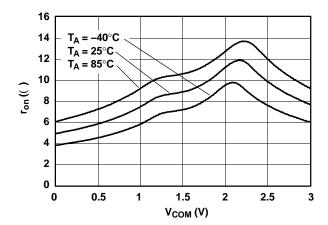


Figure 2.  $r_{on}$  vs  $V_{COM}$  ( $V_{+} = 3 V$ )



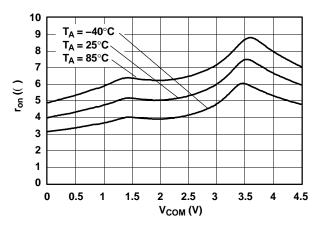


Figure 3.  $r_{on}$  vs  $V_{COM}$  ( $V_{+} = 4.5 \text{ V}$ )

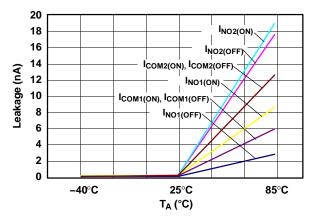


Figure 4. Leakage Current vs Temperature

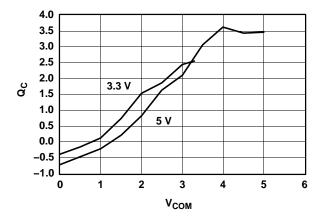


Figure 5. Charge Injection ( $Q_C$ ) vs  $V_{COM}$ 



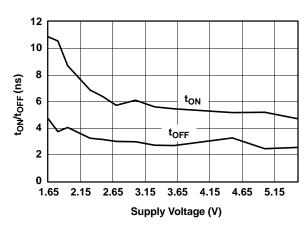


Figure 6.  $t_{ON}$  and  $t_{OFF}$  vs  $V_{+}$ 

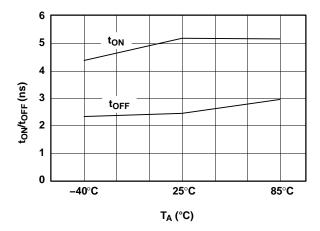


Figure 7.  $t_{ON}$  and  $t_{OFF}$  vs Temperature (V<sub>+</sub> = 5 V)

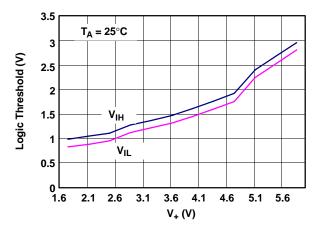


Figure 8. Logic Threshold vs V<sub>+</sub>



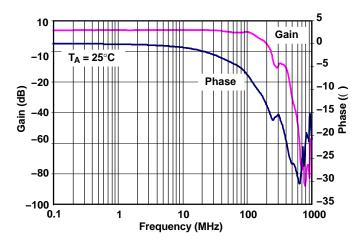


Figure 9. Bandwidth  $(V_+ = 5 V)$ 

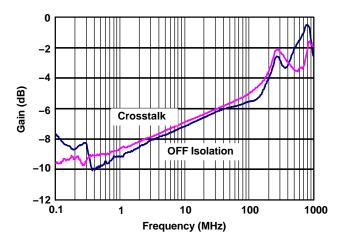


Figure 10. OFF Isolation and Crosstalk ( $V_{+} = 5 \text{ V}$ )

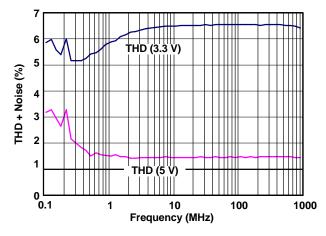


Figure 11. Total Harmonic Distortion vs Frequency



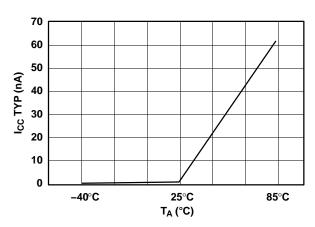


Figure 12. Power-Supply Current vs Temperature  $(V_+ = 5 V)$ 



#### **PIN DESCRIPTION**

NO.	NAME	DESCRIPTION			
1	NO1	Normally open			
2	COM1	Common			
3	IN2	Digital control to connect COM to NO			
4	GND	Digital ground			
5	NO2	Normally open			
6	COM2	Common			
7	IN1	Digital control to connect COM to NO			
8	V <sub>+</sub>	Power supply			

#### PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
V <sub>COM</sub>	Voltage at COM
V <sub>NO</sub>	Voltage at NO
r <sub>on</sub>	Resistance between COM and NO ports when the channel is ON
$\Delta r_{\sf on}$	Difference of ron between channels in a specific device
r <sub>on(flat)</sub>	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions
I <sub>NO(OFF)</sub>	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state
I <sub>NO(ON)</sub>	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open
I <sub>COM(OFF)</sub>	Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF state
I <sub>COM(ON)</sub>	Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON state and the output (NO) open
$V_{IH}$	Minimum input voltage for logic high for the control input (IN)
$V_{IL}$	Maximum input voltage for logic low for the control input (IN)
$V_{I}$	Voltage at the control input (IN)
$I_{IH},\ I_{IL}$	Leakage current measured at the control input (IN)
t <sub>ON</sub>	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.
t <sub>OFF</sub>	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF.
$Q_{C}$	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$ , $C_L$ is the load capacitance and $\Delta V_{COM}$ is the change in analog output voltage.
C <sub>NO(OFF)</sub>	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF
C <sub>NO(ON)</sub>	Capacitance at the NO port when the corresponding channel (NO to COM) is ON
$C_{COM(OFF)}$	Capacitance at the COM port when the corresponding channel (COM to NO) is OFF
C <sub>COM(ON)</sub>	Capacitance at the COM port when the corresponding channel (COM to NO) is ON
Cı	Capacitance of IN
O <sub>ISO</sub>	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.
X <sub>TALK</sub>	Crosstalk is a measurement of unwanted signal coupling from an ON channel to an adjacent ON channel (NC1 to NC2). This is measured in a specific frequency and in dB.
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.
THD	Total harmonic distortion is defined as the ratio of the root mean square (RMS) value of the second, third, and higher harmonics to the magnitude of fundamental harmonic.
I <sub>+</sub>	Static power-supply current with the control (IN) pin at V <sub>+</sub> or GND



#### PARAMETER MEASUREMENT INFORMATION

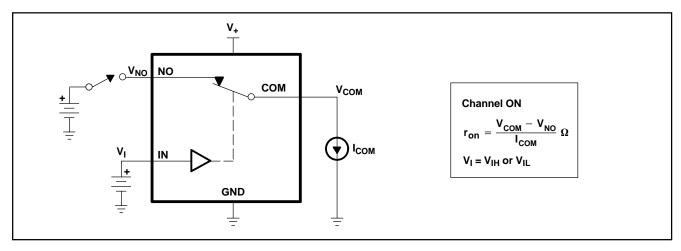


Figure 13. ON-State Resistance (ron)

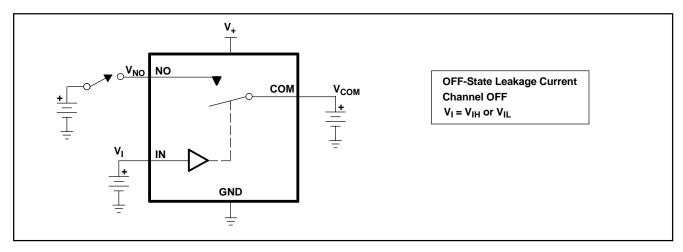


Figure 14. OFF-State Leakage Current (I<sub>COM(OFF)</sub>, I<sub>NO(OFF)</sub>)

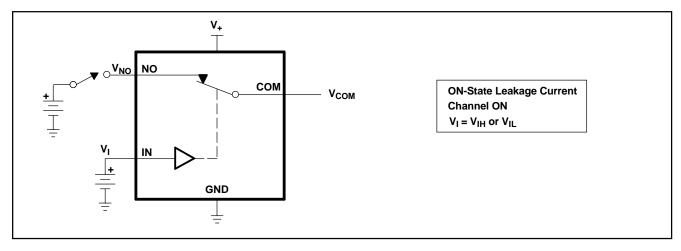


Figure 15. ON-State Leakage Current (I<sub>COM(ON)</sub>, I<sub>NO(ON)</sub>)



#### PARAMETER MEASUREMENT INFORMATION (continued)

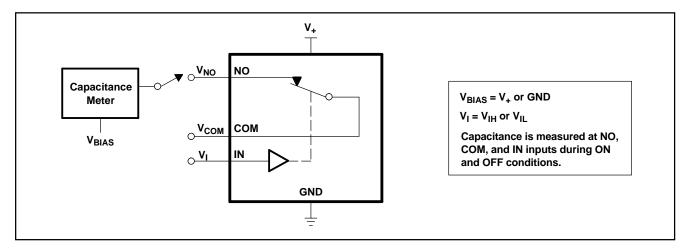
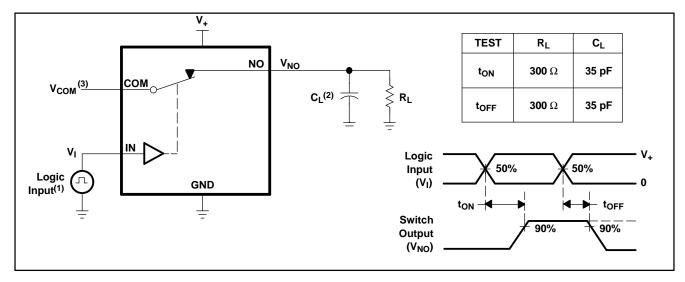


Figure 16. Capacitance (C<sub>I</sub>,  $C_{COM(OFF)}$ ,  $C_{COM(ON)}$ ,  $C_{NO(OFF)}$ ,  $C_{NO(ON)}$ )



- (1) All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r < 5 \text{ ns}$ ,  $t_f < 5 \text{ ns}$ .
- (2)  $C_L$  includes probe and jig capacitance.
- (3) See Electrical Characteristics for V<sub>COM</sub>.

Figure 17. Turn-On (t<sub>ON</sub>) and Turn-Off Time (t<sub>OFF</sub>)



#### PARAMETER MEASUREMENT INFORMATION (continued)

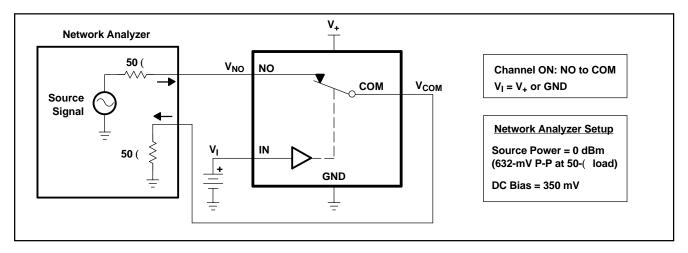


Figure 18. Bandwidth (BW)

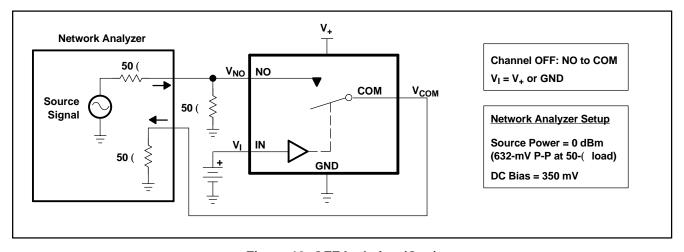


Figure 19. OFF Isolation (O<sub>ISO</sub>)

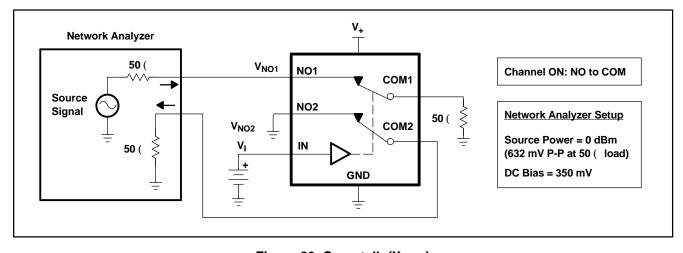
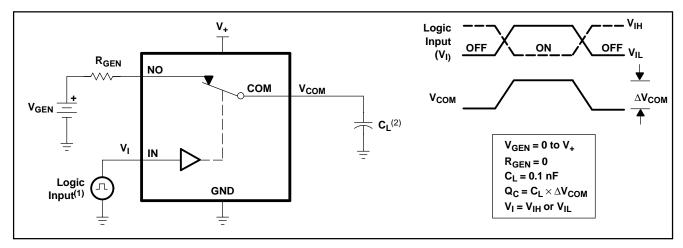


Figure 20. Crosstalk (X<sub>TALK</sub>)

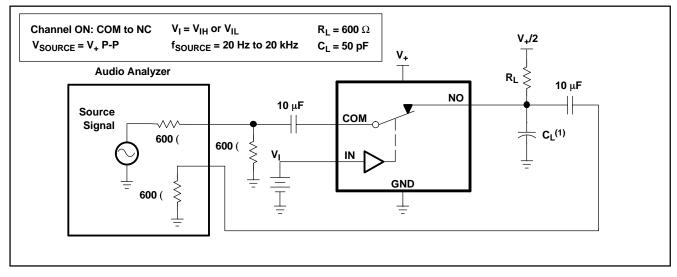


#### PARAMETER MEASUREMENT INFORMATION (continued)



- (1) All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O$  = 50  $\Omega$ ,  $t_r$  < 5 ns,  $t_f$  < 5 ns.
- (2) C<sub>1</sub> includes probe and jig capacitance.

Figure 21. Charge Injection (Q<sub>C</sub>)



(1)  $C_L$  includes probe and jig capacitance.

Figure 22. Total Harmonic Distortion (THD)



#### PACKAGE OPTION ADDENDUM

2-Sep-2005

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TS5A2066DCTR	ACTIVE	SM8	DCT	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
TS5A2066DCUR	ACTIVE	US8	DCU	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
TS5A2066DCURE4	ACTIVE	US8	DCU	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

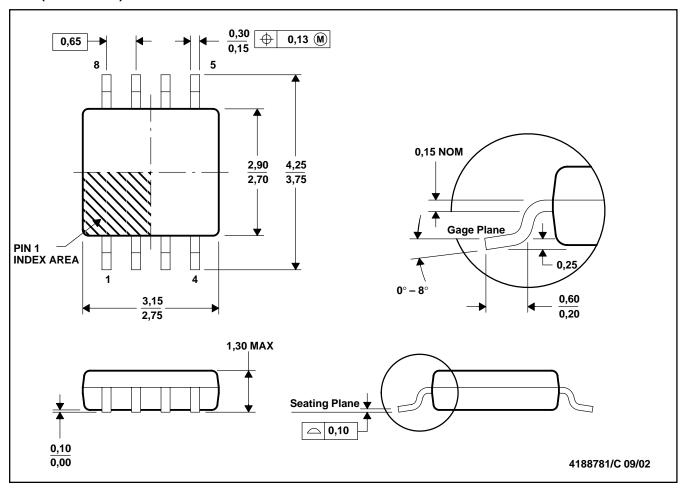
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### DCT (R-PDSO-G8)

#### PLASTIC SMALL-OUTLINE PACKAGE

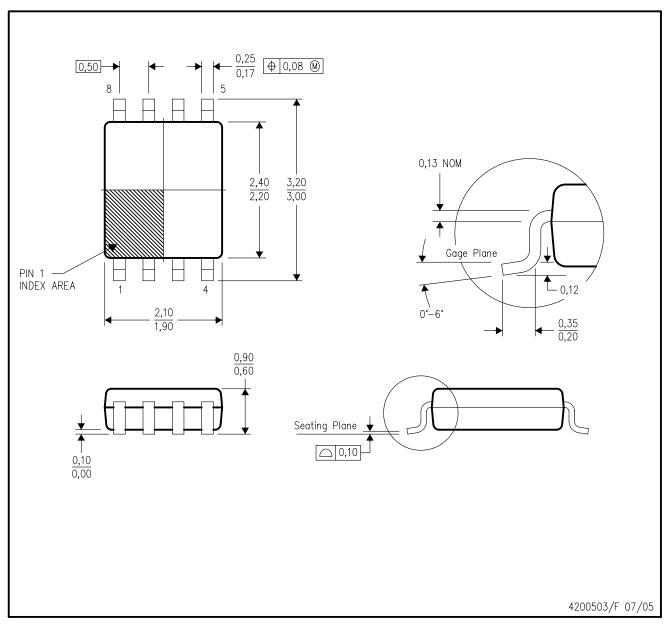


NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.C. Body dimensions do not include mold flash or protrusion
- D. Falls within JEDEC MO-187 variation DA.

## DCU (R-PDSO-G8)

## PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.



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